Tae In Lee

List of Publications by Year in Descending Order

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The third column is the impact factor (IF) of the journal, and the fourth column is the number of citations of the article.

108
papers2,322
citations19
h-index45
g-index116
ext. papers2,748
ext. citations5.9
avg, IF5.22
L-index

#	Paper	IF	Citations
108	Channel Mobility Boosting in a Poly-Si Channel Using Ge Diffusion Engineering and Hydrogen Plasma Treatment. <i>IEEE Electron Device Letters</i> , 2022 , 1-1	4.4	1
107	A wearable organic photovoltaic-thermoelectric (OPV-TE) hybrid generator to minimize the open-circuit voltage losses of OPV module. <i>Nano Energy</i> , 2021 , 93, 106775	17.1	2
106	Variable Rigidity Module with a Flexible Thermoelectric Device for Bidirectional Temperature Control. <i>Soft Robotics</i> , 2021 , 8, 662-672	9.2	4
105	Hf- and Ti-Based Organic/Inorganic Hybrid Dielectrics Synthesized via Chemical Vapor Phase for Advanced Gate Stack in Flexible Electronic Devices. <i>Advanced Electronic Materials</i> , 2021 , 7, 2001197	6.4	2
104	Transformative Electronics: Design Strategy for Transformative Electronic System toward Rapid, Bidirectional Stiffness Tuning using Graphene and Flexible Thermoelectric Device Interfaces (Adv. Mater. 10/2021). <i>Advanced Materials</i> , 2021 , 33, 2170076	24	1
103	Method to Achieve the Morphotropic Phase Boundary in HfxZr1\(\mathbb{Q}\)O2 by Electric Field Cycling for DRAM Cell Capacitor Applications. <i>IEEE Electron Device Letters</i> , 2021 , 42, 517-520	4.4	7
102	Electrical and photocurrent properties of a polycrystalline Sn-doped EGa2O3 thin film. <i>Materials Science in Semiconductor Processing</i> , 2021 , 121, 105430	4.3	9
101	Large-Area, Conformal, and Uniform Synthesis of Hybrid Polymeric Film via Initiated Chemical Vapor Deposition. <i>Macromolecular Materials and Engineering</i> , 2021 , 306, 2000608	3.9	3
100	Impact of Al doping on a hydrothermally synthesized EGaO nanostructure for photocatalysis applications <i>RSC Advances</i> , 2021 , 11, 7338-7346	3.7	4
99	Design Strategy for Transformative Electronic System toward Rapid, Bidirectional Stiffness Tuning using Graphene and Flexible Thermoelectric Device Interfaces. <i>Advanced Materials</i> , 2021 , 33, e2007239	24	8
98	Electrospun SnO2 and its composite V2O5 nanofibers for thermoelectric power generator. <i>Journal of Sol-Gel Science and Technology</i> , 2021 , 98, 183-192	2.3	2
97	Highly Reliable Charge Trap-Type Organic Non-Volatile Memory Device Using Advanced Band-Engineered Organic-Inorganic Hybrid Dielectric Stacks. <i>Advanced Functional Materials</i> , 2021 , 31, 2103291	15.6	2
96	Copolymer-Based Flexible Resistive Random Access Memory Prepared by Initiated Chemical Vapor Deposition Process. <i>Advanced Electronic Materials</i> , 2021 , 7, 2100375	6.4	0
95	Performance enhancement of p-type organic thin-film transistors by surface modification of hybrid dielectrics. <i>Organic Electronics</i> , 2021 , 96, 106250	3.5	
94	An 8-nm-thick Sn-doped polycrystalline EGa2O3 MOSFET with a flormally offloperation. <i>Applied Physics Letters</i> , 2021 , 119, 122103	3.4	4
93	Dye-Sensitized Solar CellThermoelectric Hybrid Generator Utilizing Bipolar Conduction in a Unified Element. <i>ACS Applied Energy Materials</i> , 2020 , 3, 4155-4161	6.1	5
92	Comparison of Ga2O3 and TiO2 Nanostructures for Photocatalytic Degradation of Volatile Organic Compounds. <i>Catalysts</i> , 2020 , 10, 545	4	6

91	Thermal display glove for interacting with virtual reality. Scientific Reports, 2020, 10, 11403	4.9	15
90	A Flexible Micro-Thermoelectric Generator Sticker with Trapezoidal-Shaped Legs for Large Temperature Gradient and High-Power Density. <i>Advanced Materials Technologies</i> , 2020 , 5, 2000486	6.8	5
89	Two-Dimensional Thermal Haptic Module Based on a Flexible Thermoelectric Device. <i>Soft Robotics</i> , 2020 , 7, 736-742	9.2	6
88	Schottky barrier height modulation of metalIhterlayerElemiconductor structure depending on contact surface orientation for multi-gate transistors. <i>Applied Physics Letters</i> , 2019 , 114, 012102	3.4	5
87	Enhanced Photocatalytic Degradation of 2-Butanone Using Hybrid Nanostructures of Gallium Oxide and Reduced Graphene Oxide Under Ultraviolet-C Irradiation. <i>Catalysts</i> , 2019 , 9, 449	4	5
86	Influence of Self-Heating Effect on Interface Trap Generation in Highly Flexible Single-Crystalline Si Nanomembrane Transistors. <i>Journal of Nanoscience and Nanotechnology</i> , 2019 , 19, 6481-6486	1.3	1
85	Ultrathin EOT (0.67 nm) High-k Dielectric on Ge MOSFET Using Y Doped ZrO2 With Record-Low Leakage Current. <i>IEEE Electron Device Letters</i> , 2019 , 40, 502-505	4.4	13
84	UV-Curable Silver Electrode for Screen-Printed Thermoelectric Generator. <i>Advanced Functional Materials</i> , 2019 , 29, 1901505	15.6	13
83	High-Performance Monolithic Photovoltaic Thermoelectric Hybrid Power Generator Using an Exothermic Reactive Interlayer. <i>ACS Applied Energy Materials</i> , 2019 , 2, 2381-2386	6.1	6
82	H2 High Pressure Annealed Y-Doped ZrO2 Gate Dielectric With an EOT of 0.57 nm for Ge MOSFETs. <i>IEEE Electron Device Letters</i> , 2019 , 40, 1350-1353	4.4	5
81	Mechanical and Electrical Reliability Analysis of Flexible Si Complementary Metal-Oxide-Semiconductor Integrated Circuit. <i>Journal of Nanoscience and Nanotechnology</i> , 2019 , 19, 6473-6480	1.3	
80	Ultrathin ZrO-Organic Hybrid Dielectric (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics. <i>ACS Applied Materials & Dielectronics (EOT 3.2 nm)</i> via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics. <i>ACS Applied Materials & Dielectronics (EOT 3.2 nm)</i> via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics. <i>ACS Applied Materials & Dielectronics (EOT 3.2 nm)</i> via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics. <i>ACS Applied Materials & Dielectronics (EOT 3.2 nm)</i> via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics. <i>ACS Applied Materials & Dielectronics (EOT 3.2 nm)</i> via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics. <i>ACS Applied Materials & Dielectronics (EOT 3.2 nm)</i> via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Deposition for High-Performance Flexible Electronics (EOT 3.2 nm) via Initiated Chemical Vapor Depositi	9.5	16
79	Minimally invasive medical catheter with highly flexible FDSOI-based integrated circuits 2019,		2
78	Effect of ZrO2 interfacial layer on forming ferroelectric HfxZryOz on Si substrate. <i>AIP Advances</i> , 2019 , 9, 125020	1.5	10
77	Enhanced Photocatalytic Activity of Electrospun EGa2O3 Nanofibers via In-Situ Si Doping Using Tetraethyl Orthosilicate. <i>Catalysts</i> , 2019 , 9, 1005	4	7
76	Fluorine Effects Originating From the CVD-W Process on Charge-Trap Flash Memory Cells. <i>IEEE Transactions on Electron Devices</i> , 2019 , 66, 378-382	2.9	6
75	Large Grain Ruthenium for Alternative Interconnects. IEEE Electron Device Letters, 2019, 40, 91-94	4.4	6
74	Direct Graphene Transfer and Its Application to Transfer Printing Using Mechanically Controlled, Large Area Graphene/Copper Freestanding Layer. <i>Advanced Functional Materials</i> , 2018 , 28, 1707102	15.6	26

73	Self-Powered Wearable Electrocardiography Using a Wearable Thermoelectric Power Generator. <i>ACS Energy Letters</i> , 2018 , 3, 501-507	20.1	144
72	A High-Performance Top-Gated Graphene Field-Effect Transistor with Excellent Flexibility Enabled by an iCVD Copolymer Gate Dielectric. <i>Small</i> , 2018 , 14, 1703035	11	8
71	Control of Carrier Concentration by Ag Doping in N-Type Bi2Te3 Based Compounds. <i>Applied Sciences (Switzerland)</i> , 2018 , 8, 735	2.6	10
70	Construction of a Multiway Carbon Nanotube Loudspeaker with Finely Tunable Resonance Frequencies. <i>Advanced Materials Technologies</i> , 2018 , 3, 1700197	6.8	3
69	Conformal, Wafer-Scale and Controlled Nanoscale Doping of Semiconductors Via the iCVD Process 2018 ,		2
68	High-Aspect Ratio -Gatonanorods via Hydrothermal Synthesis. Nanomaterials, 2018, 8,	5.4	26
67	Performance Degradation of Flexible Si Nanomembrane Transistors With Al2O3 and SiO2 Dielectrics Under Mechanical Stress. <i>IEEE Transactions on Electron Devices</i> , 2018 , 65, 3069-3072	2.9	1
66	A quantitative strain analysis of a flexible single-crystalline silicon membrane. <i>Applied Physics Letters</i> , 2017 , 110, 033105	3.4	8
65	Reliability improvement of a flexible FD-SOI MOSFET via heat management. <i>Applied Physics Letters</i> , 2017 , 110, 252101	3.4	6
64	Fermi-Level Unpinning Technique with Excellent Thermal Stability for n-Type Germanium. <i>ACS Applied Materials & District Applied & District</i>	9.5	11
63	Realization of High-Performance Screen-Printed Flexible Thermoelectric Generator by Improving Contact Characteristics. <i>Advanced Materials Interfaces</i> , 2017 , 4, 1700870	4.6	8
62	Multi-Layer Metallization Structure Development for Highly Efficient Polycrystalline SnSe Thermoelectric Devices. <i>Applied Sciences (Switzerland)</i> , 2017 , 7, 1116	2.6	8
61	Material Optimization for a High Power Thermoelectric Generator in Wearable Applications. <i>Applied Sciences (Switzerland)</i> , 2017 , 7, 1015	2.6	8
60	Mechanical Stability Analysis via Neutral Mechanical Plane for High-Performance Flexible Si Nanomembrane FDSOI Device. <i>Advanced Materials Interfaces</i> , 2017 , 4, 1700618	4.6	7
59	Investigation of Border Trap Characteristics in the AlON/GeO2/Ge Gate Stacks. <i>IEEE Transactions on Electron Devices</i> , 2017 , 64, 3998-4001	2.9	2
58	The Impact of an Ultrathin Y2O3 Layer on GeO2 Passivation in Ge MOS Gate Stacks. <i>IEEE Transactions on Electron Devices</i> , 2017 , 64, 3303-3307	2.9	17
57	Enhanced thermoelectric properties of screen-printed Bi0.5Sb1.5Te3 and Bi2Te2.7Se0.3 thick films using a post annealing process with mechanical pressure. <i>Journal of Materials Chemistry C</i> , 2017 , 5, 855	9 ⁷ 8565	33
56	Vertically Formed Graphene Stripe for 3D Field-Effect Transistor Applications. <i>Small</i> , 2017 , 13, 1602373	3 11	3

(2015-2017)

55	Fermi Level Depinning in Ti/GeO2/n-Ge via the Interfacial Reaction Between Ti and GeO2. <i>IEEE Transactions on Electron Devices</i> , 2017 , 64, 4242-4245	2.9	2
54	Compliment Graphene Oxide Coating on Silk Fiber Surface via Electrostatic Force for Capacitive Humidity Sensor Applications. <i>Sensors</i> , 2017 , 17,	3.8	14
53	Impedance Spectroscopy Analysis and Equivalent Circuit Modeling of Graphene Oxide Solutions. <i>Nanomaterials</i> , 2017 , 7,	5.4	10
52	Application of N-Doped Three-Dimensional Reduced Graphene Oxide Aerogel to Thin Film Loudspeaker. <i>ACS Applied Materials & Discrete Section</i> 10, 100 (1997) 100 (1997	9.5	24
51	Hybrid Integration of Graphene Analog and Silicon Complementary Metal-Oxide-Semiconductor Digital Circuits. <i>ACS Nano</i> , 2016 , 10, 7142-6	16.7	9
50	Valley-engineered ultra-thin silicon for high-performance junctionless transistors. <i>Scientific Reports</i> , 2016 , 6, 29354	4.9	2
49	Improved Drain Current Saturation and Voltage Gain in Graphene-on-Silicon Field Effect Transistors. <i>Scientific Reports</i> , 2016 , 6, 25392	4.9	10
48	Random Dopant Fluctuation-Induced Threshold Voltage Variation-Immune Ge FinFET With MetalInterlayerBemiconductor Source/Drain. <i>IEEE Transactions on Electron Devices</i> , 2016 , 63, 4167-4172	2.9	10
47	Very Low-Work-Function ALD-Erbium Carbide (ErC2) Metal Electrode on High- \$K\$ Dielectrics. <i>IEEE Transactions on Electron Devices</i> , 2016 , 63, 2858-2863	2.9	11
46	The Work Function Behavior of Aluminum-Doped Titanium Carbide Grown by Atomic Layer Deposition. <i>IEEE Transactions on Electron Devices</i> , 2016 , 63, 1423-1427	2.9	12
45	Free-Standing Graphene Thermophone on a Polymer-Mesh Substrate. Small, 2016, 12, 185-9	11	32
44	Material characteristics and equivalent circuit models of stacked graphene oxide for capacitive humidity sensors. <i>AIP Advances</i> , 2016 , 6, 035203	1.5	9
43	Effective Schottky Barrier Height Lowering of Metal/n-Ge with a TiO/GeO Interlayer Stack. <i>ACS Applied Materials & Applied & Applied Materials & Applied & A</i>	9.5	27
42	Effect of Metal Nitride on Contact Resistivity of Metal-Interlayer-Ge Source/Drain in Sub-10-nm n-Type Ge FinFET. <i>IEEE Electron Device Letters</i> , 2016 , 1-1	4.4	2
41	Effect of Hydrogen Annealing on Contact Resistance Reduction of MetalIhterlayerII-Germanium Source/Drain Structure. <i>IEEE Electron Device Letters</i> , 2016 , 1-1	4.4	10
40	Synthesis of ultrathin polymer insulating layers by initiated chemical vapour deposition for low-power soft electronics. <i>Nature Materials</i> , 2015 , 14, 628-35	27	184
39	The Mechanism of Schottky Barrier Modulation of Tantalum Nitride/Ge Contacts. <i>IEEE Electron Device Letters</i> , 2015 , 36, 997-1000	4.4	13
38	Surface Passivation of Germanium Using SF6 Plasma to Reduce Source/Drain Contact Resistance in Germanium n-FET. <i>IEEE Electron Device Letters</i> , 2015 , 36, 745-747	4.4	19

37	Wrinkle-free graphene with spatially uniform electrical properties grown on hot-pressed copper. <i>Nano Research</i> , 2015 , 8, 1075-1080	10	9
36	Large-Area, Periodic, Hexagonal Wrinkles on Nanocrystalline Graphitic Film. <i>Advanced Functional Materials</i> , 2015 , 25, 5492-5503	15.6	13
35	Improved electromigration-resistance of Cu interconnects by graphene-based capping layer 2015,		4
34	A wearable thermoelectric generator fabricated on a glass fabric. <i>Energy and Environmental Science</i> , 2014 , 7, 1959	35.4	597
33	High performance graphene field effect transistors on an aluminum nitride substrate with high surface phonon energy. <i>Applied Physics Letters</i> , 2014 , 104, 193112	3.4	15
32	Observation of Ultrafast Carrier Dynamics and Phonon Relaxation of Graphene from the Deep-Ultraviolet to the Visible Region. <i>Journal of Physical Chemistry C</i> , 2014 , 118, 6454-6461	3.8	36
31	First Demonstration of Ultra-Thin SiGe-Channel Junctionless Accumulation-Mode (JAM) Bulk FinFETs on Si Substrate with PN Junction-Isolation Scheme. <i>IEEE Journal of the Electron Devices Society</i> , 2014 , 2, 123-127	2.3	6
30	The Efficacy of Metal-Interfacial Layer-Semiconductor Source/Drain Structure on Sub-10-nm n-Type Ge FinFET Performances. <i>IEEE Electron Device Letters</i> , 2014 , 35, 1185-1187	4.4	15
29	Demonstration of Ge pMOSFETs with 6 IEOT using TaN/ZrO2/Zr-cap/n-Ge(100) gate stack fabricated by novel vacuum annealing and in-situ metal capping method 2014 ,		5
28	Performance evaluation of GaN light-emitting diodes using transferred graphene as current spreading layer. <i>Journal of Applied Physics</i> , 2014 , 115, 054503	2.5	19
27	Graphene as anode electrode for colloidal quantum dots based light emitting diodes. <i>Applied Physics Letters</i> , 2013 , 103, 043124	3.4	10
26	Doping suppression and mobility enhancement of graphene transistors fabricated using an adhesion promoting dry transfer process. <i>Applied Physics Letters</i> , 2013 , 103, 243504	3.4	13
25	Comparative study of chemically synthesized and exfoliated multilayer MoS2 field-effect transistors. <i>Applied Physics Letters</i> , 2013 , 102, 043116	3.4	33
24	Simultaneous measurement of the Seebeck coefficient and thermal conductivity in the cross-sectional direction of thermoelectric thick film. <i>Journal of Applied Physics</i> , 2012 , 112, 104511	2.5	5
23	Reduction of charge trapping in HfO2 film on a Ge substrate by trimethylaluminum pretreatment. <i>Physica Status Solidi - Rapid Research Letters</i> , 2012 , 6, 439-441	2.5	7
22	Origin of transient Vth shift after erase and its impact on 2D/3D structure charge trap flash memory cell operations 2012 ,		3
21	Development of a Measurement Method for the Thermal Conductivity of a Thick Film Prepared by a Screen-Printing Technique. <i>Journal of Electronic Materials</i> , 2012 , 41, 1170-1176	1.9	2
20	Crystallized HfLaO embedded tetragonal ZrO2 for dynamic random access memory capacitor dielectrics. <i>Applied Physics Letters</i> , 2011 , 98, 173505	3.4	11

19	Highly air-stable electrical performance of graphene field effect transistors by interface engineering with amorphous fluoropolymer. <i>Applied Physics Letters</i> , 2011 , 98, 153505	3.4	38
18	Lanthanum-Oxide-Doped Nitride Charge-Trap Layer for a TANOS Memory Device. <i>IEEE Transactions on Electron Devices</i> , 2011 , 58, 3314-3320	2.9	4
17	Analysis on switching mechanism of graphene oxide resistive memory device. <i>Journal of Applied Physics</i> , 2011 , 110, 044506	2.5	89
16	Thin-Film Thermoelectric Module for Power Generator Applications Using a Screen-Printing Method. <i>Journal of Electronic Materials</i> , 2011 , 40, 615-619	1.9	46
15	Structural and compositional dependence of gadolinium-aluminum oxide for the application of charge-trap-type nonvolatile memory devices. <i>Applied Physics Letters</i> , 2010 , 96, 052907	3.4	3
14	Non-volatile memory using graphene oxide for flexible electronics 2010 ,		2
13	Wide memory window in graphene oxide charge storage nodes. <i>Applied Physics Letters</i> , 2010 , 96, 14310	93.4	82
12	Improvement of memory performance by high temperature annealing of the Al2O3 blocking layer in a charge-trap type flash memory device. <i>Applied Physics Letters</i> , 2010 , 96, 222902	3.4	25
11	High-Performance MIM Capacitors Using HfLaO-Based Dielectrics. <i>IEEE Electron Device Letters</i> , 2010 , 31, 17-19	4.4	14
10	Low-Voltage High-Performance Pentacene Thin-Film Transistors With Ultrathin PVP/High- \$kappa\$ HfLaO Hybrid Gate Dielectric. <i>IEEE Electron Device Letters</i> , 2010 ,	4.4	11
9	Flexible Resistive Switching Memory Device Based on Graphene Oxide. <i>IEEE Electron Device Letters</i> , 2010 , 31, 1005-1007	4.4	126
8	Performance Improvement in Charge-Trap Flash Memory Using Lanthanum-Based High- \$kappa\$ Blocking Oxide. <i>IEEE Transactions on Electron Devices</i> , 2009 , 56, 2746-2751	2.9	19
7	Aluminum-Doped Gadolinium Oxides as Blocking Layer for Improved Charge Retention in Charge-Trap-Type Nonvolatile Memory Devices. <i>IEEE Transactions on Electron Devices</i> , 2009 , 56, 2739-27	749	15
6	Monolayer graphene growth on sputtered thin film platinum. <i>Journal of Applied Physics</i> , 2009 , 106, 104.	3 <u>0.9</u>	78
5	Cubic-Structured \$hbox{HfO}_{2}\$ With Optimized Doping of Lanthanum for Higher Dielectric Constant. <i>IEEE Electron Device Letters</i> , 2009 , 30, 623-625	4.4	34
4	Energy-Band-Engineered Unified-RAM (URAM) Cell on Buried \$hbox{Si}_{1 - y}hbox{C}_{y}\$ Substrate for Multifunctioning Flash Memory and 1T-DRAM. <i>IEEE Transactions on Electron Devices</i> , 2009 , 56, 641-647	2.9	O
3	Metal Carbides for Band-Edge Work Function Metal Gate CMOS Devices. <i>IEEE Transactions on Electron Devices</i> , 2008 , 55, 2469-2474	2.9	9
2	Design of low cost, scalable, and high-performance TiS2 thermoelectric materials via wet ball-milling process. <i>Journal of Materials Science: Materials in Electronics</i> ,1	2.1	O

Design of Electrochemically Reduced Graphene Oxide/Titanium Disulfide Nanocomposite Sensor for Selective Determination of Ascorbic Acid. *ACS Applied Nano Materials*,

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